


MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			
1	07/06/2017	First Issue.	

Display Features			
Character Count	2 x 20		
Appearance	White on Black		
Logic Voltage	5V		
Interface	Parallel / SPI / I2C		
Font Set	English / Japanese / Cyrillic		
Character Height	5.57		
Module Size	84.50 x 19.28 x 2.05 mm		
Operating Temperature	-40°C ~ +80°C	Box Quantity	Weight / Display
Construction	TAB	---	---

\* - For full design functionality, please use this specification in conjunction with the SSD1311 specification.(Provided Separately)

Display Accessories	
Part Number	Description
MPBV4-Iss2	Direct solder-to-2mm pitch DIL pinout interface board. Compatible with: 0.7, 0.8, 0.845 and 1mm pitch pads.
MCIB-13 V2	Direct solder OLED character interface board. Used in conjunction with MCIB-12 and UC32.

Optional Variants	
Appearance	Voltage
Blue on Black Green on Black Yellow on Black	
Interface	

Mechanical Specifications					
Module Size	84.50 x 19.28 x 2.05 (Without Backlight)				W x H x D mm
Active Area	73.52 x 11.52	W x H mm	Hole-to-Hole	---	W x H mm
Character Size	3.22 x 5.57	W x H mm	Character Pitch	3.70 x 5.95	W x H mm
Dot Size	0.62 x 0.67	W x H mm	Dot Pitch	0.65 x 0.70	W x H mm

Technical drawing of a detector assembly, showing top, side, and detail views with dimensions and labels.

**Top View Dimensions (mm):**

- Overall width: 118.30
- Overall height: 19.28,  $\varnothing 2$
- Internal dimensions (from top edge): 18.28,  $\varnothing 2$  (Polarizer), 0.50, 2.88, 3.70, 2.70, 0.50
- Internal dimensions (from left edge): 84.50,  $\varnothing 2$ ; 80.50,  $\varnothing 2$ ; 79.50,  $\varnothing 2$  (Polarizer); 75.52 (VA); 73.52 (AA)

**Side View Dimensions (mm):**

- Overall height: 11.52 (AA), 13.52 (VA), 0.50
- Internal dimensions (from top edge): 10.00, 5.00
- Internal dimensions (from left edge): 2.05,  $\varnothing 1$ ; 2.20

**Detail View Dimensions (mm):**

- Overall width: 31.13
- Overall height: 1.89
- Internal dimensions (from top edge): 0.38, 5.95, 5.57, 0.62, 0.65, 3.22, 0.48, 0.70
- Internal dimensions (from left edge): 0.10,  $\varnothing 3$ ; 0.90,  $\varnothing 3$ ; 1.80,  $\varnothing 3$ ; 3.60,  $\varnothing 2$

**Labels and Notes:**

- Remove Tape  $t=0.15\text{mm Max}$
- Polarizer  $t=0.25\text{mm}$
- shade chip  $t=0.1\text{mm}$
- Protective Tape  $11*8*0.05\text{mm}$
- Contact side
- Alignment Mark
- Reference Mechanical Design
- SCALE: 3/1
- Segment 49 (Column 2)
- Segment 99 (Column 1)

MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			

## Block Diagram



Display Position	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
DD RAM Address	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10	11	12	13
DD RAM Address	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50	51	52	53

MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			

## Pin Layout

Pin	Symbol	Description																		
1	NC	No connection																		
2	VSL	This is segment voltage (output low level) reference pin. When external VSL is not used, this pin should be left open. When external VSL is used, connect with resistor and diode to ground (details depend on application).																		
3	VSS	Ground pin. It must be connected to external ground.																		
4	REGVDD	Internal VDD regulator selection pin in 5V I/O application mode. When this pin is pulled HIGH, internal VDD regulator is enabled (5V I/O application). When this pin is pulled LOW, internal VDD regulator is disabled (Low voltage I/O application).																		
5	SHLC	This pin is used to determine the Common output scanning direction. COM scan direction <table><tr><td>SHLC</td><td>COM scan direction</td></tr><tr><td>1</td><td>COM0 to COM31 (Normal)</td></tr><tr><td>0</td><td>COM31 to COM0 (Reverse)</td></tr></table> (1) 0 s connected to VSS (2) 1 s connected to VDDIO	SHLC	COM scan direction	1	COM0 to COM31 (Normal)	0	COM31 to COM0 (Reverse)												
SHLC	COM scan direction																			
1	COM0 to COM31 (Normal)																			
0	COM31 to COM0 (Reverse)																			
6	SHLS	This pin is used to change the mapping between the display data column address and the Segment driver. SEG scan direction <table><tr><td>SHLS</td><td>SEG direction</td></tr><tr><td>1</td><td>SEG0 to SEG99 (Normal)</td></tr><tr><td>0</td><td>SEG99 to SEG0 (Reverse)</td></tr></table> (1) 0 s connected to VSS (2) 1 s connected to VDDIO	SHLS	SEG direction	1	SEG0 to SEG99 (Normal)	0	SEG99 to SEG0 (Reverse)												
SHLS	SEG direction																			
1	SEG0 to SEG99 (Normal)																			
0	SEG99 to SEG0 (Reverse)																			
7	VDD	Power Supply For Core Logic Operation. VDD can be supplied externally or regulated internally. In LV IO application (internal VDD is disabled), this is a power input pin. In 5V IO application (internal VDD is enabled), VDD is regulated internally from VDDIO. A capacitor should be connected between VDD and VSS under all circumstances.																		
8	VDDIO	Low voltage power supply and power supply for interface logic level in both Low Voltage I/O and 5V I/O application. It should match with the MCU interface voltage level and must be connected to external source.																		
9	BS0	MCU bus interface selection pins. Select appropriate logic setting as described in the following table. BS2, BS1 and BS0 are pin select.																		
10	BS1	Bus Interface selection																		
11	BS2	<table><tr><td>BS[2:0]</td><td>Interface</td></tr><tr><td>000</td><td>Serial Interface</td></tr><tr><td>001</td><td>Invalid</td></tr><tr><td>010</td><td>I<sup>2</sup>C</td></tr><tr><td>011</td><td>Invalid</td></tr><tr><td>100</td><td>8-bit 6800 parallel</td></tr><tr><td>101</td><td>4-bit 6800 parallel</td></tr><tr><td>110</td><td>8-bit 8080 parallel</td></tr><tr><td>111</td><td>4-bit 8080 parallel</td></tr></table> (1) 0 s connected to VSS (2) 1 s connected to VDDIO	BS[2:0]	Interface	000	Serial Interface	001	Invalid	010	I <sup>2</sup> C	011	Invalid	100	8-bit 6800 parallel	101	4-bit 6800 parallel	110	8-bit 8080 parallel	111	4-bit 8080 parallel
BS[2:0]	Interface																			
000	Serial Interface																			
001	Invalid																			
010	I <sup>2</sup> C																			
011	Invalid																			
100	8-bit 6800 parallel																			
101	4-bit 6800 parallel																			
110	8-bit 8080 parallel																			
111	4-bit 8080 parallel																			
12	GPIO	GPIO pin. Details refer to OLED command DCh.																		
13	CS#	Chip Select Input Connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW (active LOW). In I2C mode, this pin must be connected to VSS.																		
14	RES#	Reset Signal Input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin pull HIGH during normal operation.																		

MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			

15	D/C#	Data/Command Control Pin Connecting to the MCU. When the pin is pulled HIGH, the data at D[7:0] will be interpreted as data. When the pin is pulled LOW, the data at D[7:0] will be transferred to a command register. In I2C mode, this pin acts as SA0 for slave address selection. When serial interface is selected, this pin must be connected to VSS.																				
16	R/W#(WR#)	Read / Write Control Input Pin Connecting to the MCU interface. When 6800 interface mode is selected, this pin will be used as Read/Write (R/W#) selection input. Read mode will be carried out when this pin is pulled HIGH and write mode when LOW. When 8080 interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.																				
17	E(RD#)	MCU Interface Input. When 6800 interface mode is selected, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled HIGH and the chip is selected. When 8080 interface mode is selected, this pin receives the Read (RD#) signal. Read operation is initiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.																				
18-25	D0~D7	Bi-directional Data Bus Connecting to the MCU data bus. Unused pins are recommended to tie LOW. When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SID and D2 will be the serial data output: SOD. When I2C mode is selected, D2, D1 should be tied together and serve as SDAout, SDAin in application and D0 is the serial clock input, SCL.																				
26	IREF	Segment Output Current Reference pin. IREF is supplied externally. A resistor should be connected between this pin and VSS to maintain current of around 15uA.																				
27	ROM0	These pins are used to select Character ROM; select appropriate logic setting as described in the following table. ROM1 and ROM0 are pin select as shown in below table: Character ROM selection <table><tr><th>ROM1</th><th>ROM0</th><th>ROM</th></tr><tr><td>0</td><td>0</td><td>A</td></tr><tr><td>0</td><td>1</td><td>B</td></tr><tr><td>1</td><td>0</td><td>C</td></tr><tr><td>1</td><td>1</td><td>S/W selectable <sup>(3)</sup></td></tr></table>	ROM1	ROM0	ROM	0	0	A	0	1	B	1	0	C	1	1	S/W selectable <sup>(3)</sup>					
ROM1	ROM0	ROM																				
0	0	A																				
0	1	B																				
1	0	C																				
1	1	S/W selectable <sup>(3)</sup>																				
28	ROM1	Note (1) 0 is connected to VSS (2) 1 is connected to VDDIO																				
29	OPR0	This pin is used to select the character number of character generator. Character RAM selection <table><tr><th>OPR1</th><th>OPR0</th><th>CGROM</th><th>CGRAM</th></tr><tr><td>1</td><td>1</td><td>256</td><td>0</td></tr><tr><td>0</td><td>1</td><td>248</td><td>8</td></tr><tr><td>1</td><td>0</td><td>250</td><td>6</td></tr><tr><td>0</td><td>0</td><td>240</td><td>8</td></tr></table>	OPR1	OPR0	CGROM	CGRAM	1	1	256	0	0	1	248	8	1	0	250	6	0	0	240	8
OPR1	OPR0	CGROM	CGRAM																			
1	1	256	0																			
0	1	248	8																			
1	0	250	6																			
0	0	240	8																			
30	OPR1	Note (1) 0 is connected to VSS (2) 1 is connected to VDDIO																				
31	VCOMH	COM signal deselected voltage level. A capacitor should be connected between this pin and VSS. No external power supply can connect to this pin.																				
32	VCC	Power Supply for Panel Driving Voltage. This is also the most positive power voltage supply pin. It is supplied by external high voltage source.																				
33	NC	No connection.																				

MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			

# Font Map

Upper 4bit Lower 4bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	HHHH
LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
LHHH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
HLHH	(4)															
HHLL	(5)															
HHLH	(6)															
HHHL	(7)															
HHHH	(8)															

MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			

Upper 4bit Lower 4bit	LLLL	LL LH	LL HL	LL HH	LH LL	LH LH	LH HL	LH HH	HLLL	HLLH	HLHL	HLHH	HHLL	HH LH	HH HL	HHHH
LLLL	CG RAM (1)															
LL LH	(2)															
LL HL	(3)															
LL HH	(4)															
LH LL	(5)															
LH LH	(6)															
LH HL	(7)															
LH HH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
HLHH	(4)															
HHLL	(5)															
HH LH	(6)															
HH HL	(7)															
HHHH	(8)															

MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			



Upper 4bit Lower 4bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	HHHH
LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
LHHH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
HLHH	(4)															
HHLL	(5)															
HHLH	(6)															
HHHL	(7)															
HHHH	(8)															

MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			



Absolute Maximum Ratings						
Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage for Logic	VDDIO	---	-0.3	---	6.00	V
Input Voltage	VI	---	-0.3	---	VDD	°C
Operating Temperature	TOP	---	-40	---	80	°C
Storage Temperature	TST	---	-40	---	85	°C

Electronic Characteristics						
Item	Symbol	Condition	Minimum	Typical	Maximum	Unit
Input High Voltage	VIH	---	0.80xVDD	---	---	V
Input Low Voltage	VIL	---	---	---	0.20xVDD	V
Output High Voltage	VOH	IOH=0.5mA	0.90xVDD	---	---	V
Output Low Voltage	VOL	IOL=0.5mA	---	---	0.10xVDD	V
Supply Voltage for Logic	VDDIO	---	4.80	5.00	5.30	V
Supply Voltage for Display	VCC	---	9.50	10.00	10.50	V
50% Checkboard Operating Current.	ICC	VDD=5V	14	15	18	mA
CIE <sub>x</sub> (White)	---	(CIE1931)	0.26	0.28	0.30	---
CIE <sub>y</sub> (White)	---	(CIE1931)	0.30	0.32	0.34	---

OLED Characteristics						
Item	Symbol	Condition	Minimum	Typical	Maximum	Unit
Viewing Angle	(V)θ	---	160	---	---	Deg
	(H)φ	---	160	---	---	Deg
Contrast Ratio	CR	Dark	2000:1	---	---	---
Response Time	T Rise	---	---	10	---	μs
	T Fall	---	---	10	---	μs
Display with 50% Checkboard Brightness			60	80	---	cd/m <sup>2</sup>

OLED Life Time			
Item	Conditions	Typical	Remark
Operating Life Time	Ta=25°C. Initial checkboard brightness. 50%.	50,000 Hours	---

MCOT22005A1V-EWM	2 x 20	Euro/Jap/Cyrillic	OLED Module
Specification			
Version: 1		Date: 10/10/2017	
Revision			